

Features

- Superior circuit protection
- Overcurrent protection
- Blocks surges up to rated voltage limit
- High-speed performance
- Small SMT package
- RoHS compliant*

Applications

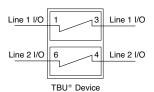
- RS-485 interfaces
- Exposed sense and data lines
- Factory automation
- Protection modules and dongles
- Process control equipment
- Test and measurement equipment
- General electronics

TBU-DF Series - TBU® High-Speed Protectors

General Information

The TBU-DF Series of Bourns® TBU® products are low capacitance dual bidirectional high-speed Electronic Current Limiters (ECLs), constructed using MOSFET semiconductor technology, and designed to protect against faults caused by short circuits, overvoltage transients and faults in battery cells, up to rated limits.

The TBU® high-speed protector placed in the system circuit will monitor the current with the MOSFET detection circuit triggering to provide an effective barrier behind which sensitive electronics will not be exposed to large voltages or currents during transient events.



The TBU® device is provided in a surface mount DFN package and meets industry standard requirements such as RoHS and Pb Free solder reflow profiles.

Absolute Maximum Ratings (@ T_A = 25 °C Unless Otherwise Noted)

Symbol	Parameter	Part Number	Value	Unit
\/.	Peak impulse voltage withstand with duration less than 10 ms	TBU-DF055-xxx-WH	550	V
V _{imp}	reak impulse voltage withstand with duration less than 10 ms	TBU-DF085-xxx-WH	850	V
M	Continuous A.C. BMS voltage	TBU-DF055-xxx-WH	250	V
V _{rms}	Continuous A.C. RMS voltage	TBU-DF085-xxx-WH	425	V
T _{op}	Operating temperature range	-55 to +125	°C	
T _{stg}	Storage temperature range	-65 to +150	°C	
T _{amax}	Maximum Ambient Temperature	+125	°C	

Electrical Characteristics (@ T_A = 25 °C Unless Otherwise Noted)

Symbol	Parameter		Part Number	Min.	Тур.	Max.	Unit
Itrigger	Current required for the protected state	TBU-DFxxx-050-WH TBU-DFxxx-300-WH TBU-DFxxx-500-WH	50 300 500	75 450 750	100 600 1000	mA	
R _{device}	Series resistance of the TBU® device	V _{imp} = 550 V I _{trigger} (min.) = 50 mA V _{imp} = 550 V I _{trigger} (min.) = 300 mA V _{imp} = 550 V I _{trigger} (min.) = 500 mA V _{imp} = 850 V I _{trigger} (min.) = 50 mA V _{imp} = 850 V I _{trigger} (min.) = 300 mA V _{imp} = 850 V I _{trigger} (min.) = 500 mA		12 6 5 23 15 12		26 14 13 38 26 25	Ω
R _{match}	Package resistance m			+0.5	Ω		
t _{block}	Time for the device to		1		μs		
IQ	Current through the tri	ggered TBU® device with 50 Vdc circuit v		0.5		mA	
V _{reset}	Voltage below which t	12	16	20	V		
R _{th(j-a)}	Junction to ambient -		125		°C/W		
R _{th(j-a)}	Junction to ambient -		50		°C/W		

Environmental Characteristics

Parameter	Value
Moisture Sensitivity Level	1
ESD Classification (HBM)	1B

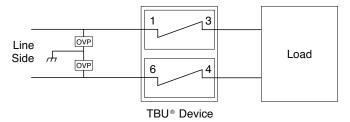


WARNING Cancer and Reproductive Harm - www.P65Warnings.ca.gov

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Reference Application

The TBU® devices are general use protectors used in a wide variety of applications, including telecommunications, industrial communications and automotive battery management systems. The maximum voltage rating of the TBU® device should never be exceeded. Where necessary, an OVP device should be employed to limit the maximum voltage. A cost-effective protection solution combines Bourns® TBU® protection devices with a pair of Bourns® TISP® Overvoltage Protectors or MOVs. For bandwidth sensitive applications, a Bourns® GDT may be substituted for the MOV.



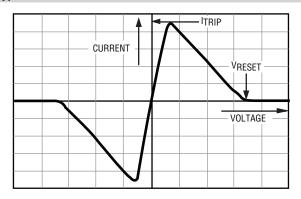
Basic TBU Operation

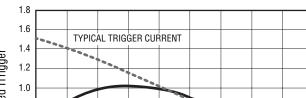
The TBU® device, constructed using MOSFET semiconductor technology, placed in the system circuit will monitor the current with the MOSFET detection circuit triggering to provide an effective barrier behind which sensitive electronics are not exposed to large voltages or currents during transient events. When operated, the TBU® device will limit the current to less than the I_{trigger} value within the t_{block} duration. If voltage above V_{reset} is continuously sustained, the TBU® device will subsequently reduce the current to a quiescent current level within a period of time that is dependent upon the applied voltage.

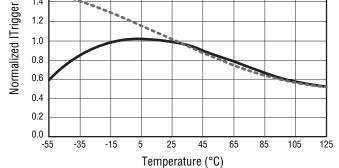
After the surge, the TBU® device resets when the voltage across the TBU® device falls to the V_{reset} level. The TBU® device will automatically reset on lines which have no DC bias or have DC bias below V_{reset} (such as unpowered signal lines).

Performance Graphs

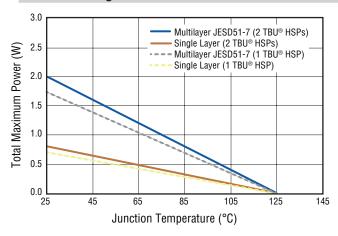
Typical V-I Characteristics





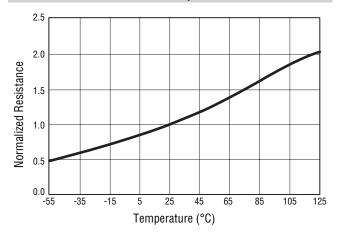


Power Derating Curve

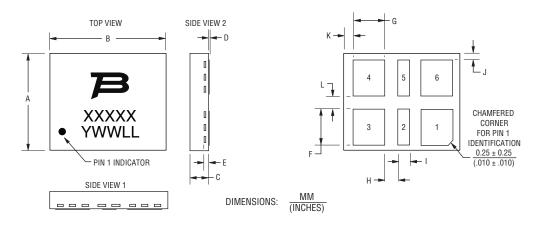


Normalized Resistance vs. Temperature

Normalized Itrigger vs. Temperature



Product Dimensions



Dim.	Min.	Nom.	Max.			
А	<u>5.40</u>	<u>5.50</u>	<u>5.60</u>			
	(.213)	(.217)	(.220)			
В	6.40	6.50	6.60			
	(.252)	(.256)	(.260)			
С	<u>0.80</u>	<u>0.90</u>	1.00			
	(.031)	(.035)	(.039)			
D	<u>0.00</u> (.000)		<u>0.05</u> (.002)			
E	0.20 (.008) REF.					
F	1.90	2.00	2.10			
	(.075)	(.079)	(.083)			
G	1.75	1.85	1.95			
	(.069)	(.073)	(.077)			
Н	<u>0.65</u>	<u>0.70</u>	0.75			
	(.026)	(.028)	(.030)			
I	<u>0.70</u>	0.80	0.90			
	(.028)	(.031)	(.035)			
J	<u>0.30</u>	<u>0.35</u>	<u>0.40</u>			
	(.012)	(.014)	(.016)			
К	0.25	0.30	0.35			
	(.010)	(.012)	(.014)			
L	<u>0.75</u>	<u>0.80</u>	<u>0.85</u>			
	(.030)	(.031)	(.033)			

Pad #	Pin Out
1	Line 1 In/Out
2	NU (Not Used)
3	Line 1 In/Out
4	Line 2 In/Out
5	NU (Not Used)
6	Line 2 In/Out

NOTES:

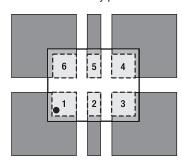
- Pin 1 Indicator is laser marked; radius and location within the Pin 1 terminal.
 - Pin 1 dot size: 0.500 ± 0.125 mm / $(.020 \pm .005$ in.).
- Pin 2 and 5 are NU (Not Used) and must be left unconnected; do not connect to In/Out lines, do not connect to system Ground.
- 3. Coplanarity on exposed pads shall not exceed 0.08 mm / (.003 in.).
- 4. Warpage shall not exceed 0.10 mm / (.004 in.) on all surfaces.
- 5. Exposed tie bars at package side are not plated.

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Recommended Pad Layout

TBU® High-Speed Protectors have a 100 % matte-tin termination finish. For improved thermal dissipation, the recommended layout uses PCB copper areas which extend beyond the exposed solder pad. The exposed solder pads should be defined by a solder mask which matches the pad layout of the TBU® device in size and spacing. It is recommended that they should be the same dimension as the TBU® pads but if smaller solder pads are used, they should be centered on the TBU® package terminal pads and not more than 0.10-0.12 mm (0.004-0.005 in.) smaller in overall width or length. Solder pad areas should not be larger than the TBU® pad sizes to ensure adequate clearance is maintained. The recommended stencil thickness is 0.10-0.12 mm (0.004-0.005 in.) with a stencil opening size 0.025 mm (0.0010 in.) less than the solder pad size. Extended copper areas beyond the solder pad significantly improve the junction to ambient thermal resistance, resulting in operation at lower junction temperatures with a corresponding benefit of reliability. All pads should soldered to the PCB, including pads marked as NC or NU but no electrical connection should be made to these pads. Care should be taken to assure no resistive path exists between the NC or NU pins to any other point to avoid

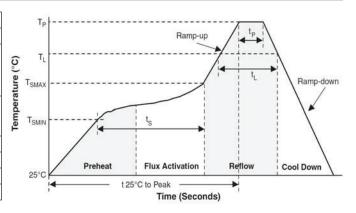
unexpected performance issues. For minimum parasitic capacitance, it is recommended that signal, ground or power signals are not routed beneath any pad. For minimum parasitic capacitance, it is recommended that signal, ground or power signals are not routed beneath any pad.

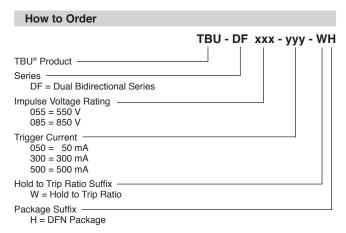


Dark grey areas show added PCB copper area for better thermal resistance.

Reflow Profile

Profile Feature	Pb-Free Assembly
Average Ramp-Up Rate (Tsmax to Tp)	3 °C/sec. max.
Preheat - Temperature Min. (Tsmin) - Temperature Max. (Tsmax) - Time (tsmin to tsmax)	150 °C 200 °C 60-180 sec.
Time maintained above: - Temperature (TL) - Time (tL)	217 °C 60-150 sec.
Peak/Classification Temperature (Tp)	260 °C
Time within 5 °C of Actual Peak Temp. (tp)	20-40 sec.
Ramp-Down Rate	6 °C/sec. max.
Time 25 °C to Peak Temperature	8 min. max.





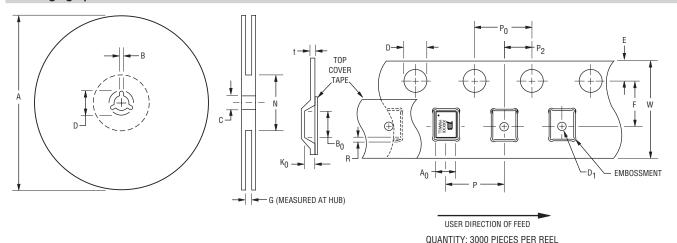
MANUFACTURER'S TRADEMARK 5 DIGIT PRODUCT CODE: 1ST ALPHA CHARACTER INDICATES PRODUCT FAMILY: F = TBU-DF SERIES 20 M& 3RD DIGITS INDICATE TRIGGER CURRENT. PIN 1 INDICATOR MANUFACTURING DATE CODE: 1ST DIGIT INDICATES THE YEAR. 21D & 3RD DIGITS INDICATE THE WEEK NUMBER. 21D & 3RD DIGITS INDICATE THE WEEK NUMBER.

Specifications are subject to change without notice.

Users should verify actual device performance in their specific applications.

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Packaging Specifications



В D Ν G Min. Max. Min. Max. Min. Max. Min. Max. Ref. Ref. 328.5 331 2.0 2.4 12.8 13.5 17.0 17.4 16.5 100 ± 1.5 (0.669)(0.690)(12.93)(13.05)(0.079)(0.094)(0.504)(.531)(0.650) (3.94 ± 0.059)

A ₀		В	0	D ₀		D ₁		Е		F	
Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	max.
5.75 (0.224)	5.95 (0.234)	6.75 (0.266)	6.95 (0.274)	1.5 (0.059)	1.6 (0.063)	1.5 (0.059)	-	1.65 (0.065)	1.85 (0.073)	7.4 (0.291)	$\frac{7.6}{(0.299)}$
K ₀		F	•	P	0	P	2	F	3	1	:
Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.
1.05	1.25	7.9	8.1	3.9	4.1	1.9	2.1	_ 0	0.5	0.25	0.35
(0.041)	(0.049)	(0.311)	(0.319)	(0.159)	(0.161)	(0.075)	(0.083)	(0)	(.020)	(0.010)	(0.014)

W						
Min.	Max.					
15.7	16.3					
(0.618)	(0.642)					

DIMENSIONS:

MM (INCHES)

BOURNS®

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OOO «ЛайфЭлектроникс" "LifeElectronics" LLC

ИНН 7805602321 КПП 780501001 P/C 40702810122510004610 ФАКБ "АБСОЛЮТ БАНК" (ЗАО) в г.Санкт-Петербурге К/С 3010181090000000703 БИК 044030703

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С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

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- Входной контроль качества.
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- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
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